AIO-3399J

Six-Core 64-Bit industrial Mainboard

V1.3



Update History

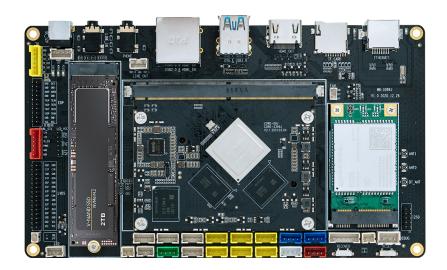
Version	Date	Details
V1.0	2017-09-29	Initial version
V1.1	2017-12-22	Updated interface markings and PCB Size
V1.2	2018-08-24	Add housing
V1.3	2020-07-21	Core-3399J V2, Update interface description

Directory

١.	Overview	3
2.	Specificationd	4
3.	Size.	5
1.	Interface description.	6
5	Interface definitions	7
	1、(J2) DC_IN 4 PIN 2.0 pitch interface	7
	2、(J44) LINE-OUT 3 PIN 2.0 pitch interface	7
	3、(J25) FAN 3 PIN 1.25 pitch interface	7
	4、((J27) MINI PCIE 3G/4G	7
	5、(J34) I2S0 10 PIN Dual 2.0 pitch interface	8
	6、(J26)DEBUG 3 PIN 2.54 pitch interface.	8
	7、(J7)POWER KEY 2 PIN 2.0 pitch interface	8
	8、(J18)SPI2 6 PIN 2.0 pitch interface	8
	9、(J5) RS232 4 PIN 2.0 pitch interface	9
	10、(J6) RS485 4 PIN 2.0 pitch interface	9
	11、(J108) UART1 4 PIN 2.0 pitch interface	9
	12、(J107) UART2 4 PIN 2.0 pitch interface	9
	13、(J12) USB-HUB3 4 PIN 2.0 pitch interface	9
	14、(J13) USB-HUB4 4 PIN 2.0 pitch interface	9
	15、(J10) USB HUB1 4 PIN 2.0 pitch interface	.10
	16、(J11) USB-HUB2 4 PIN 2.0 pitch interface	.10
	17、(J105) USB-HUB5 4 PIN 2.0 pitch interface	.10
	18、(J104) USB-HUB6 4 PIN 2.0 pitch interface	.10
	19、(J109) KEY 4 PIN 2.0 pitch interface	.10
	20、(J47) I2C4 4 PIN 2.0 pitch interface	.10
	21、(J17) SPEAKER 4 PIN 2.0 pitch interface	.11
	22、(J41) PWR_3V3 4 PIN 2.0 pitch interface	.11
	23、(J42) PWR_5V0 4 PIN 2.0 pitch interface	.11
	24、(J43) IR Receiver 4 PIN 2.0 pitch interface	.11
	25、(J14) MIC 2 PIN 2.0 pitch interface	.11
	26、(J102) LED 3 PIN 2.0 pitch interface	.11
	27、(J3) RTC 2 PIN 1.25 pitch interface	.12
	28、(CON40) LVDS 双排 30 PIN 2.0 pitch interface	.12
	29、(J45) BL_CTL 6 PIN 2.0 pitch interface(GPIO)	.12
	30、(J101) LCD_VCC 6 PIN 2.0 pitch interface.	.12
	31、(JP1)EDP Dual 20 PIN 2.0 pitch interface(GPIO)	.13
	32、(J24) TP 6 PIN 2.0 pitch interface	.13
3	About US	14

Overview

Using RK3399 Six-Core (A72x2+A53x4) 64-Bit CPU, up to 1.8Ghz, integrated Quad-Core Mali-T864 GPU. Onboard M.2 PCIe, 4G LTE interface, multiple display interface and serial port. Support the Android/Linux/Ubuntu system and open source code for the second development. It can be quickly applied to a variety of industries.



A New Generation of Six-Core 64-Bit Processor

AIO-3399J uses the newest ARM Cortex-A72 architecture, six core 64 bit CPU, The frequency up to 1.8GHz. Compared with Cortex-A57, the processing performance is 100%, The speed is faster, and the performance is stronger.

Compatible with All Mainstream Display

Support LVDS/eDP/MIPI/HDMI interface, Support 5-100 inch displays, can drive the mainstream display screen.

Precise and Reliable Process

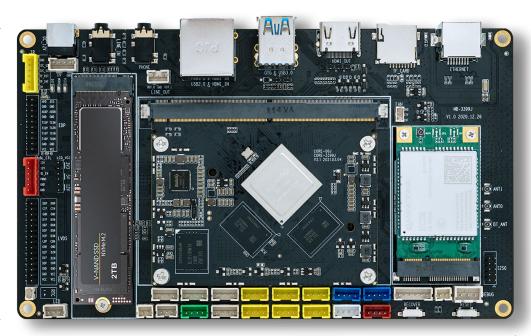
4mil immersion gold process, core board finger anti-corrosion, 7x24 hours stable working , 4 stud fixed, solid and reliable

Open Source

Supporting the source code, tutorials, technical information and development tools can be downloaded from the website, development, learning, industry applications become more simple and convenient.

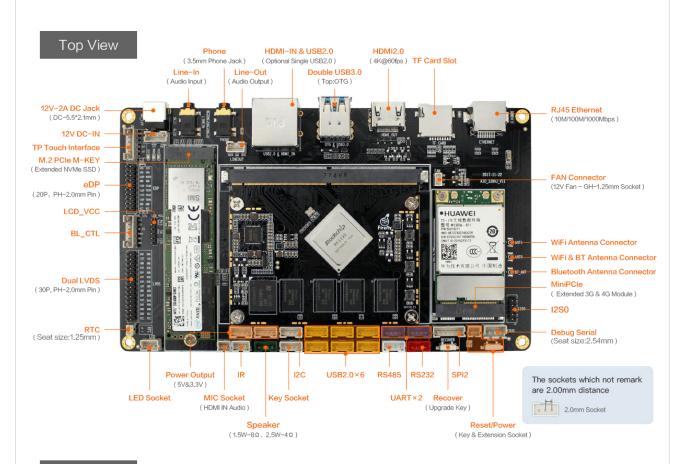
Specification

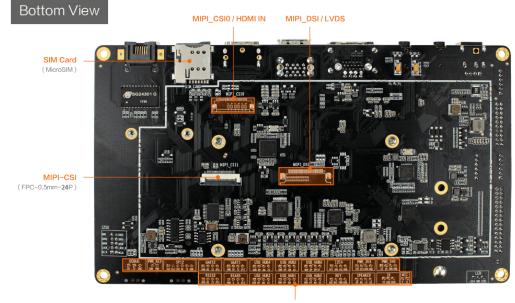
	Rockchip RK3399 (28nm HKMG Process) , up to 1.8GHz Six-Core ARM 64-bit processor(2×Cortex-A72 + 4×Cortex-A53)
CPU	ARM Mali-T860 MP4 Quad-Core GPU Support OpenGL ES1.1/2.0/3.0/3.1, OpenCL and DirectX 11, Support AFBC
	Support 4K VP9 and 4K 10bits H265/H264 video decoding, up to 60fps 1080P multi-format video decoding (MVC, mpeg-1/2/4, VP8) 1080P video encoding, which supports h.264, VP8 format
RAM	Dual-Channel DDR3 (1GB/2GB/4GB Optional)
Storage	High-Speed eMMC 5.1 (8GB/16GB/32GB/128GB Optional) Support MicroSD (TF) Card PCIE M.2 NGFF (M-KEY) , for extend NVMe SSD
Wirologe	2.4GHz/5GHz Dual-band WiFi (Support 802.11a/b/q/n/ac protocol, 2x2 MIMO) Bluetooth 4.1 (Support BLE)
Wireless	3G/4G LTE (Mini-PCle) Module (Ooptional) Support WCDMA, EVDO, 4G full netcom
Ethernet	10/100/1000Mbps (RJ45)
	Video Output Interface: 1 x HDMI 2.0,up to 4K@60fps , support HDCP 1.4/2.2 1 x HDMI-IN,support 1080P@60fps input
Display	Screen Interface (Support dual display): 1 x Dual-Channel MIPI-DSI, up to 2560x1600@60fps 1 x Dual-Channel LVDS, support 1920x1200 (24bit) @60fps 1 x eDP 1.3 (4 lanes with 10.8Gbps)
Audio	1 x HDMI audio output 1 x MIC audio input 1 x Analog audio (via 3.5mm Combo Audio Jack for audio input and ouput) 1 x Line-in for audio input 1 x Line-out (socket) for audio output 1 x SPDIF interface for audio output 1 x Double -Speakers, (support left and right output, built-in double $4\Omega/2.7W$, $8\Omega/1.6W$ PA) 1 x I2S, supports 8 channels
Camera	2 x MIPI-CSI Camera interface, (built-in Dual-ISP, Maximum 13Mpixel or dual 8Mpixel)
PCle	1 x Mini PCle, for LTE 4G 1 x PCle M.2 (M-Key), for extend NVMe SSD
SIM	1 x SIM Slot,for Mini-PCle 4G LTE module
USB	1 x USB2.0 HOST, 2 x USB3.0 HOST, 6 x USB2.0 Socket
Serial	1 x RS232 , 2 x TTL Serial, 1 x RS485
IR	1 x IR Receiver, support remote control
RTC	1 x RTC, Onboard battery socket (supports rtc wake up)
Key	1 x Reset Key, 1 x Recover Key
Interface	SPI、I2C、ADC、GPIO、Key,and power input and output interface
Power	DC12V - 2A (via DC 5.5*2.1mm Jack or 2.54mm Socket)
OS	Android 7.1、Android 6.0、Ubuntu 16.04、u-boot
Programming	Support C、C++、Kotlin、Java、Shell、Pyhon etc.
Upgrade	Support TF-Card upgrade, USB upgrade
Size	182.8mm x 107.1mm
High Limit	19mm (Top) , 2.5mm (Bottom)
Screw Hole	Ф 3mm
PCB Parameters	Motherboard (4-layer design), Core Board (8-layer design), 1.6mm (thickness), Immersion Gold Technology



→ 182.8 mm

Interface



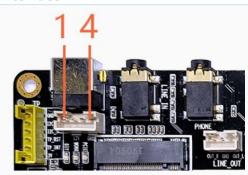


Socket Function Introduction



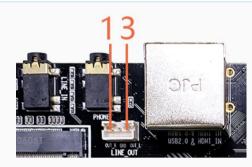
5. Interface Definition

1、(J2) DC_IN 4 PIN 2.0 Pitch Interface



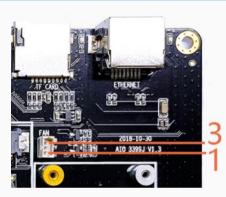
NO.	Definition	Power/V	NO.	Definition	Power/V
1	DC_12V	12	3	GND	
2	DC 12V	12	4	GND	

2、(J44) LINE-OUT 3 PIN 2.0 Pitch Interface



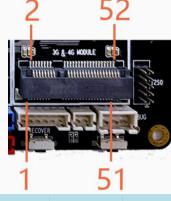
NO.	Definition	Power/V	NO.	Definition	Power/V
1	LINE_OUT_R	3.0	3	LINE_OUT_L	3.0
2	GND				

3、(J25) FAN 3 PIN 1.25 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	FAN_INT	12	3	GND	
2	FAN_12V	12			

4、((J27) MINI PCIE-3G/4G

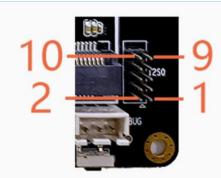


	1))			
NO.	Definition	Power/V	NO.	Definition	Power/V
1	NC		2	VCC3V8_3G	3.8
3	NC		4	GND	
5	NC		6	NC	
7	NC		8	UIM_PWR	1.8
9	GND		10	UIM_DAT	1.8
11	NC		12	UIM_CLK	1.8
13	NC		14	UIM_RST	1.8
15	GND		16	NC	
17	NC		18	GND	
19	NC		20	NC	
21	GND		22	PE_RST	3.3
23	NC		24	NC	
25	NC		26	GND	
27	GND		28	NC	
29	GND		30	NC	
31	NC		32	NC	



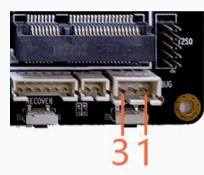
33	NC		34	GND	
35	GND		36	HOST0_DM	3.3
37	GND		38	HOSTO_DP	3.3
39	VCC3V8_3G	3.8	40	GND	
41	VCC3V8_3G	3.8	42	NC	
43	GND		44	NC	
45	NC		46	NC	
47	NC		48	NC	
49	NC		50	GND	
51	NC		52	VCC3V8_3G	3.8

5、(J34) I2SO 10 PIN Dual 2.0 Pitch Interface



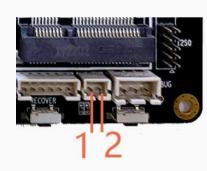
NO.	Definition	Power/V	NO.	Definition	Power/V
1	I2S0_SCLK	1.8	2	12S0_CLK	1.8
3	I2S0_LRCK_TX	1.8	4	I2S0_LRCK_RX	1.8
5	12S0_SDO0	1.8	6	12S0_SDI0	1.8
7	12S0_SDO2	1.8	8	I2S0_SDO1	1.8
9	GND		10	12S0 SDO3	1.8

6、(J26)DEBUG 3 PIN 2.54 Pitch Interface



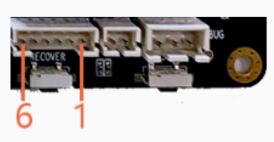
NO.	Definition	Power/V	NO.	Definition	Power/V
1	UART2_RXD	3.0	3	GND	
2	UART2_TXD	3.0			

7, (J7)POWER KEY 2 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	PWR	5.0	2	GND	

8、(J18)SPI2 6 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	VCC3V3_SYS	3.3	4	GPIO2_B1/SPI2_RXD	1.8
2	GPIO2_B3/SPI2_CLK	1.8	5	GPIO2_B2/SPI2_TXD	1.8
3	GPIO2_B4/SPI2_CSN0	1.8	6	GND	



9、(J5) RS232 4 PIN 2.0 Pitch Interface



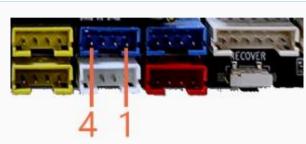
NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	RS232_TX	3.3
2	RS232_RX	3.3	4	VCC3V3_UART	3.3

10、(J6) RS485 4 PIN 2.0 Pitch Interface



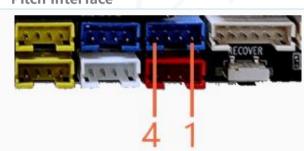
NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	RS485_B	3.3
2	RS485 A	3.3	4	VCC3V3_UART	3.3

11、(J108) UART1 4 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	RXD	3.3
2	RXD	3.3	4	VCC3V3_UART	3.3

12、(J107) UART2 4 PIN 2.0 Pitch Interface



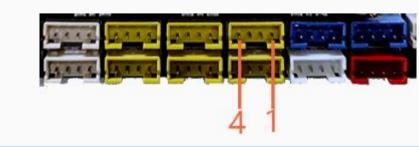
NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	TX_C	3.3
2	RX_C	3.3	4	VCC3V3_UART	3.3

13、(J12) USB-HUB3 4 PIN 2.0 Pitch Interface



		141			
NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	HUB_DM3	3.3
2	HUB_DP3	3.3	4	VCC5V0_HOST3	5.0

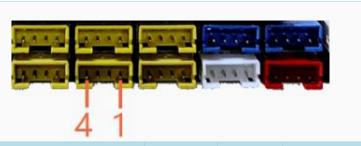
14、(J13) USB-HUB4 4 PIN 2.0 Pitch Interface



4 1					
NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	HUB_DM4	3.3
2	HUB_DP4	3.3	4	VCC5V0_HOST4	5.0



15、(J10) USB-HUB1 4 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	HUB_DM1	3.3
2	HUB_DP1	3.3	4	VCC5V0_HOST1	5.0

16、(J11) USB-HUB2 4 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	HUB_DM2	3.3
2	HUB DP2	3.3	4	VCC5V0 HOST2	5.0

17、(J105) USB-HUB5 4 PIN 2.0 Pitch Interface



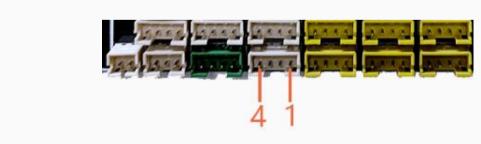
NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	HUB_DM5	3.3
2	HUB_DP5	3.3	4	VCC5V0_HOST5	5.0

18、(J104) USB-HUB6 4 PIN 2.0 Pitch Interface



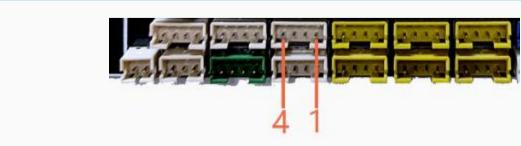
NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	HUB_DM6	3.3
2	HUB_DP6	3.3	4	VCC5V0_HOST6	5.0

19、(J109) KEY 4 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	ADC_IN0	1.8	3	PWR_ON	5.0
2	RECOVER_KEY	1.8	4	GND	

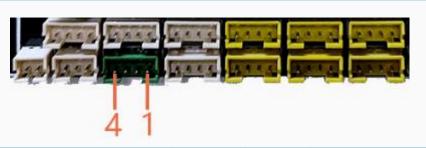
20、(J47) I2C4 4 PIN 2.0 Pitch Interface



4 1					
NO.	Definition	Power/V	NO.	Definition	Power/V
1	VCC3V3_SYS	3.3	3	I2C4_SCL	3.0
2	I2C4_SDA	3.0	4	GND	

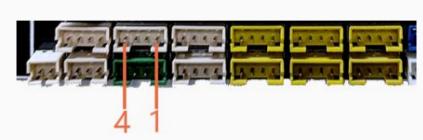


21、(J17) SPEAKER 4 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	SPK_RN	10W@8Ω	3	SPK_LN	10W@8Ω
2	SPK_RP	1000@022	4	SPK_LP	1000@022

22, (J41) PWR_3V3 4 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	VCC3V3_SYS	3.3	3	GND	
2	VCC3V3_SYS	3.3	4	GND	

23、(J42) PWR_5V0 4 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	VCC_SYS	5.0	3	GND	
2	VCC_SYS	5.0	4	GND	

24、(J43) IR Receiver 4 PIN 2.0 Pitch Interface



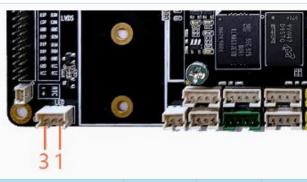
NO.	Definition	Power/V	NO.	Definition	Power/V
1	IR_VCC	5.0	3	IR_INT	1.8
2	GND				

25、(J14) MIC 2 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	MIC_IN1N	3.0	2	MIC_IN1P	3.0

26、(J102) LED 3 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	LED4	3.3	3	LED5	3.3
2	GND				

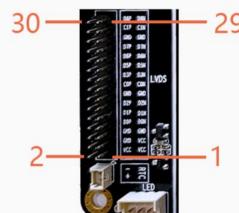


27、(J3) RTC 2 PIN 1.25 Pitch Interface



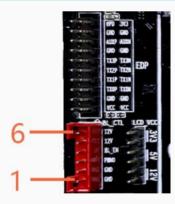
NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		2	VCC_RTC	3.3~5.0

28、(CON40) LVDS Dual 30 PIN 2.0 Pitch Interface



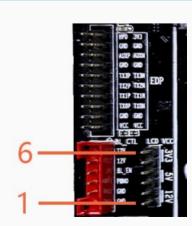
*VCC_LCD 通过跳帽	J101 选择	16,06	Ī		
NO.	Definition	Power/V	NO.	Definition	Power/V
1	VCC_LCD	3.3V/5V/12VOptiona I*	2	VCC_LCD	3.3V/5V/12VOptiona
3	VCC_LCD	3.3V/5V/12VOptiona I*	4	GND	
5	GND		6	GND	
7	LVDS_D0N	3.3	8	LVDS_D0P	3.3
9	LVDS_D1N	3.3	10	LVDS_D1P	3.3
11	LVDS_D2N	3.3	12	LVDS_D2P	3.3
13	GND		14	GND	
15	LVDS_CLK0N	3.3	16	LVDS_CLK0P	3.3
17	LVDS_D3N	3.3	18	LVDS_D3P	3.3
19	LVDS_D5N	3.3	20	LVDS_D5P	3.3
21	LVDS_D6N	3.3	22	LVDS_D6P	3.3
23	LVDS_D7N	3.3	24	LVDS_D7P	3.3
25	GND		26	GND	
27	LVDS_CLK1N	3.3	28	LVDS_CLK1P	3.3
29	LVDS_D8N	3.3	30	LVDS_D8P	3.3

29、(J45) BL_CTL 6 PIN 2.0 Pitch Interface(GPIO)



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		4	BL_EN	3.0
2	GND		5	DC_12V	12
3	LCD_BL_PWM0	3.0	6	DC_12V	12

30、(J101) LCD_VCC 6 PIN 2.0 Pitch Interface

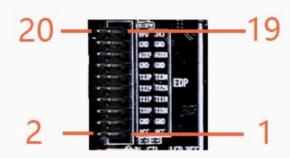


NO.	Definition	Power/V	NO.	Definition	Power/V
1	DC_12V	12V	4	VCC_LCD_S	3.3V/5.0V/12VOptio



					nal
2	VCC_LCD_S	3.3V/5.0V/12VOption	5	VCC3V3_SYS_S3	3.3V
3	VCC_SYS	5V	6	VCC_LCD_S	3.3V/5.0V/12VOptio nal

31、(JP1)EDP Dual 20 PIN 2.0 Pitch Interface(GPIO)



*VCC_LCD 通过跳帽 J101 选择

VOO_LOD						
NO.	Definition	Power/V	NO.	Definition	Power/V	
1	VCC_LCD	3.3V/5.0V/12VOptional	2	VCC_LCD	3.3V/5.0V/12VOptio	
					nal	
3	GND		4	GND		
5	EDP_TX0N	1.8	6	EDP_TX0P	1.8	
7	EDP_TX1N	1.8	8	EDP_TX1P	1.8	
9	EDP_TX2N	1.8	10	EDP_TX2P	1.8	
11	EDP_TX3N	1.8	12	EDP_TX3P	1.8	
13	GND		14	GND		
15	EDP_AUXN	1.8	16	EDP_AUXP	1.8	
17	GND		18	GND		
19	VCC_3V0	3.0	20	LCD_HPD	3.0	

32、(J24) TP 6 PIN 2.0 Pitch Interface



NO.	Definition	Power/V	NO.	Definition	Power/V
1	VCC_3V0	3.0	2	TP_INT	3.0
3	TP_RST	3.0	4	I2C4_SCL_TP	3.0
5	I2C4_SDA_TP	3.0	6	GND	

About US

T-Chip Intelligent Technology (Zhongshan) Co., Ltd., established in 2005, has more than ten years of technological product research and development capabilities, and has nearly 100 patents and software copyrights. As a national high-tech enterprise, we focus on the research and development, production and sales of open source smart hardware, Internet of Things, and digital audio products, while also provide overall solutions with smart hardware products.

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Firefly team has more than 70 R&D members, with excellent research and development capabilities of schematic design, PCB layout, board mass production, embedded development, system development, application development and so on. We accelerate the research and development process for many technology entrepreneurs and start-ups, and provide professional technical services.

Make technology simpler, Make life smarter - is the idea of Firefly team. We hope that through Firefly's open source products and technical services, the research and development of various technological products will become efficient and simple, and intelligent technology can be integrated into life.

Firefly is committed to providing enterprise customers with long-term stable and reliable industrial products and services, and continuously creating value for customers.

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